

Product Change Notification / GBNG-06VMOY041

Date:

10-Aug-2020

Product Category:

Bluetooth Module

PCN Type:

Manufacturing Change

Notification Subject:

CCB 4347 Final Notice: Implement new packing material (JEDEC tray) and packing changes for selected RN42Nxxx module.

Affected CPNs:

GBNG-06VMOY041_Affected_CPN_08102020.pdf GBNG-06VMOY041_Affected_CPN_08102020.csv

Notification Text:

PCN Status: Final notification

PCN Type: Manufacturing Change

Microchip Parts Affected: Please open one of the icons found in the Affected CPNs section above.

NOTE: For your convenience Microchip includes identical files in two formats (.pdf and .xls).

Description of Change: Implement new packing material (JEDEC tray) and packing changes for selected RN42Nxxx module.

Pre Change: Plastic tray

Post Change: JEDEC standard tray

Pre and Post Change Summary:

	Pre Change – Transparent Tray	Post Change – JEDEC Tray			
Tray Color	Transparent/Clear	Black			
No. modules per tray	64	84			
Base Quantity Multiple (BQM) Minimum order quantity	64 modules	84 modules			
Tray Dimension (WxLxH)	188 x 288 x 12.1 mm	135.9 x 322.6 x 7.62 mm			
Bakable @150 C, max	NO	YES			
Tray matrix	8 x 8	7 x 12			
Tray photos	See Pre and Post Change attachment for the photo				

Impacts to Data Sheet:

None

Change Impact:

None

Reason for Change:

To improve manufacturability by qualifying JEDEC standard tray.

Change Implementation Status:

In Progress

Estimated First Ship Date:

August 15, 2020 (date code: 2033)

NOTE: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

Time Table Summary:

	August 2020				
Workweek	31	32	33	34	35
Qual Report Availability			Х		
Final PCN Issue Date			Х		
Estimated Implementation Date			Х		

Method to Identify Change:

Traceability code and packing material

Qualification Report:

Please open the attachments included with this PCN labeled as PCN_#_Qual_Report.

Revision History:

August 10, 2020: Issued final notification. Attached the Qualification Report. Provided estimated first ship date to be on August 15, 2020.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

Attachments:

PCN_GBNG-06VMOY041_Pre and Post Change Summary.pdf PCN_GBNG-06VMOY041_Qual_Report.pdf

Please contact your local Microchip sales office with questions or concerns regarding this notification.

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If you wish to <u>change your PCN profile</u>, <u>including opt out</u>, please go to the <u>PCN home page</u> select login and sign into your myMicrochip account. Select a profile option from the left navigation bar and make the applicable selections. GBNG-06VMOY041 - CCB 4347 Final Notice: Implement new packing material (JEDEC tray) and packing changes for selected RN42Nxxx module.

Affected Catalog Part Numbers (CPN)

RN42N-I/RM RN42NAPL-I/RM545 RN42NAPL-I/RM RN42N-I/RMCOS477 RN42NHCI-I/RM RN42NHID-I/RM RN42NU-I/RM RN42NU-I/RM477